

• General Description

The AGM13T15C combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

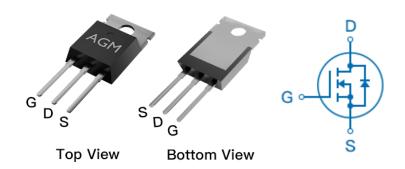
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
135V	15.5mΩ	58A

TO-220 Pin Configuration



Package Marking and Ordering Information

Devi	ice Marking	Device	Device Package	Reel Size	Tape width	Quantity
AG	M13T15C	AGM13T15C	TO-220			1000

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	135	V
VGS	Gate-Source Voltage (VDS=0V) ±20		V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	58	А
	Drain Current-Continuous(Tc=100°ℂ)	39	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	232	А
PD	Maximum Power Dissipation(Tc=25℃)	120	W
	Maximum Power Dissipation(Tc=100℃)	60	W
EAS	Avalanche energy (Note 3)	21	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 175	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		62.5	°C/W
RθJC	Thermal Resistance Junction-Case ¹		1.25	°C/W



Table 3. Electrical Characteristics (TJ=25^oCunless otherwise noted)

Fable 3. Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off St	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	135	147		V
IDSS	Zero Gate Voltage Drain Current	VDS=135V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2	2.8	4	V
gFS	Forward Transconductance	VDS=5V,ID=5A		17		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=10A		15.5	21	mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance	VDS=40V,VGS=0V,		1192		pF
Coss	Output Capacitance	F=1MHZ		145		pF
Crss	Reverse Transfer Capacitance			11		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		2.8		Ω
Switching	Times					
td(on)	Turn-on Delay Time			10		nS
tr	Turn-on Rise Time	VGS=10V,VDS=75V,		6.5		nS
td(off)	Turn-Off Delay Time	RGEN=3Ω, RL=7.5Ω		16		nS
tf	Turn-Off Fall Time			7.0		nS
Qg	Total Gate Charge			33		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=75V, ID=20A		7.2		nC
Qgd	Gate-Drain Charge	ID-20A		7.2		nC
Source-D	rain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				58	А
VSD	Forward on Voltage	VGS=0V,IS=20A			1.2	V
trr	Reverse Recovery Time	IF=20A , dI/dt=100A/μs ,		30		ns
Qrr	Reverse Recovery Charge	TJ=25℃		135		nc

Notes 1. The maximum current rating is package limited.

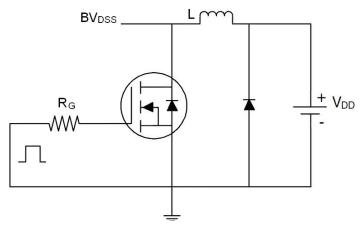
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}$ C,VDD=50V,Vgs=10V,ID=20.5A, L=0.1mH,RG=25ohm

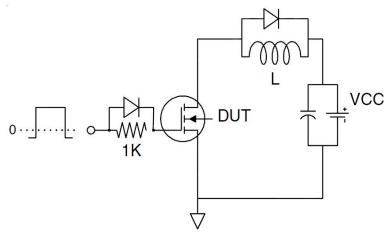


Test Circuit

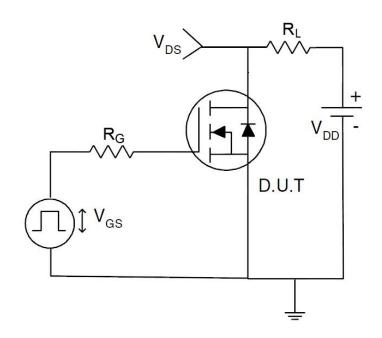
1) Eas test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

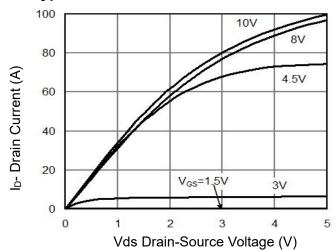


Figure 1 Output Characteristics

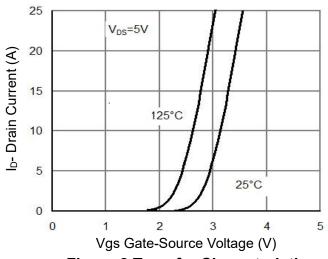
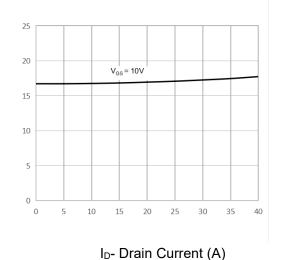


Figure 2 Transfer Characteristics



Rdson On-Resistance(m Ω)

Figure 3 Rdson- Drain Current

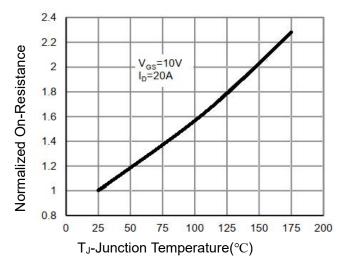


Figure 4 Rdson-Junction Temperature

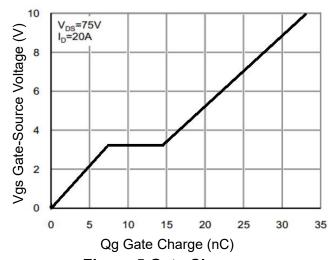


Figure 5 Gate Charge

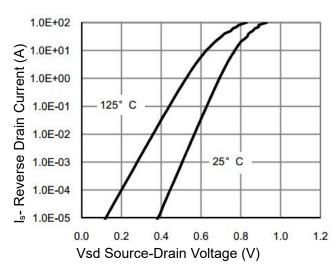
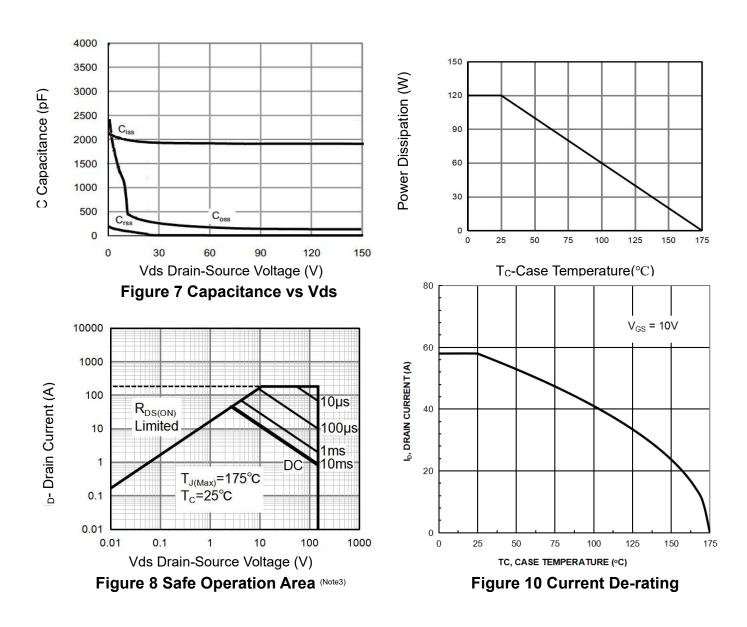


Figure 6 Source- Drain Diode Forward





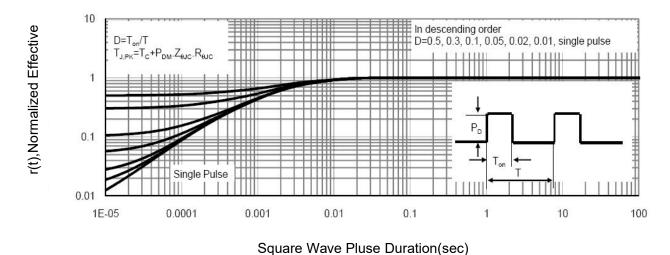
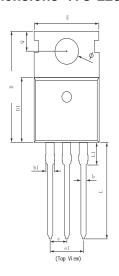
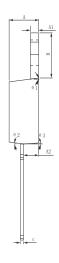


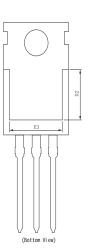
Figure 11 Normalized Maximum Transient Thermal Impedance



•Dimensions (TO-220)

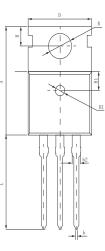


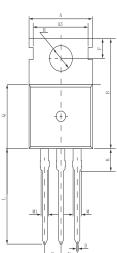




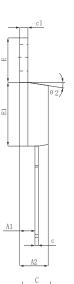
SYMBOL.	MILLIMETER			
SIMBUL	MIN	Typ.	MAX	
A	4.370	4. 570	4. 700	
A1	1.250	1.300	1.400	
A2	2.150	2. 350	2. 550	
b	0.700	0.800	0.950	
bl	1.170	1. 270	1.470	
С	0.450	0.500	0.600	
D	15. 100	15.600	16.100	
D1	8.800	9.100	9.400	
D2	5.500	6.300 REF		
Е	9.700	10.000	10.300	
E3	7.000	7.600 REF		
е	2. 540 BSC			
e1	5. 080 BSC			
L	13. 200	13.500	13.800	
L1		3. 100	3.400	
Н	6.250	6.500	1. 352	
Φ	3.400	3. 600	3.800	
Q	2.600	2.800	3.000	
θ 1	7° TYP			
θ 2	7° TYP			
θ 3	3° TYP			

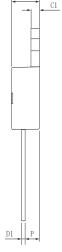


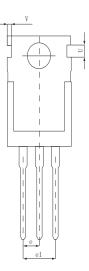


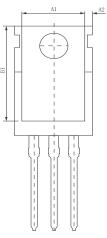












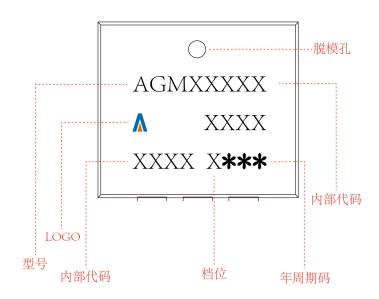
SYMBOL.		MILLIMETER	
OTMEOL	MIN	Typ.	MAX
A	15.400	15.600	15.800
A1	2. 350	2. 400	2. 500
A2	4.400	4.500	4. 700
b	0.700	0.800	0.900
b2	1. 180	1. 310	1. 440
С	0.480	0.500	0. 560
c1	1. 290	1. 300	1. 320
D	9.800	10.000	10.200
Е	6. 400	6. 500	6.600
E1	9.000	9.100	9. 200
е	2. 420	2.540	2.660
e1	4. 840	5. 080	5. 320
Н	2. 730	2. 800	2.870
H1	2. 400	2.500	2.600
L	13.020	13. 370	13.720
R	3. 500	3. 600	3. 730
R1	1.400	1.500	1.600
U	1.650	1.750	1.850
V	0.580	0.680	0.780
θ 1	2°	2.5°	3°
θ2	6.5°	7°	7.5°

Symbo1	Dimensions (mm)
A	10.0±0.3
A1	8.0±0.2
A2	0.94±0.1
A3	8.7±0.1
В	15.6±0.4
B1	13.2±0.2
С	4.5±0.2
C1	1.3±0.2
D	0.8±0.2
D1	0.5±0.1
Е	10.0±0.3
F	2.8±0.1
Н	3.6±0.1
K	3.1±0.2
L	1.3±0.4
M	1.38±0.1
M1	1.28±0.1
N	2.54 (typ)
P	2.4±0.3
Q	9.15±0.25

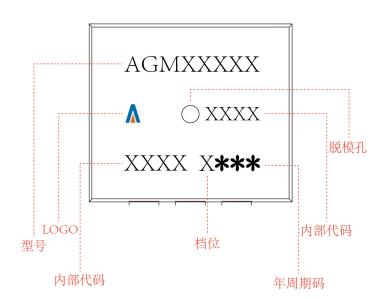


TO-220 Marking Instructions:

Model1:



Model2:





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